

CAN signal improvement transceiver









Features

- Compliant to ISO 11898-2:2016, SAE J2284-4/-5
- Tx-based CAN FD SIC according to CiA 601-4
- Loop delay symmetry for CAN FD data frames up to 8 Mbit/s
- Standby mode with minimized quiescent current
- Wake-up indication on the RxD output
- Wide common mode range for electromagnetic immunity (EMI)
- Excellent ESD robustness ±8 kV HBM and IEC 61000-4-2
- CAN short circuit proof to ground, battery and V_{CC}
- TxD timeout function
- Very low CAN bus leakage current in power-down state
- Overtemperature protection
- Protected against automotive transients according to ISO 7637 and SAE J2962-2
- Green Product (RoHS compliant)

Potential applications

- Gateway module
- Body control module (BCM)
- Engine control unit (ECU)
- **ADAS**
- Radar

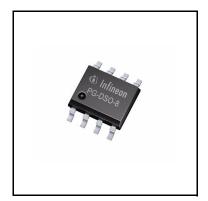
Product validation

Qualified for automotive applications. Product validation according to AEC-Q100.

Description

The TLE9371SJ is the first high-speed CAN transceiver generation with signal improvement, used in HS Controller Area Networks (CAN) for automotive applications and also for industrial applications. It is designed to fulfill the requirements of ISO 11898-2 (2016) physical layer specification as well as SAE J1939 and SAE J2284.

The TLE9371SJ is available in a halogen free and RoHS compliant PG-DSO-8 package.



CAN signal improvement transceiver



As an interface between the physical bus layer and the HS CAN, the TLE9371SJ protects the microcontroller against interference generated in the network. A very high ESD robustness and the optimized RF immunity allows the use in automotive applications without additional protection devices, such as suppressor diodes or common mode chokes.

While the TLE9371SJ is not supplied the transmitter is switched off and behaves passive with the lowest possible load to all other nodes of the HS CAN.

Based on the high symmetry of the CANH and CANL output signals, the TLE9371SJ provides very low electromagnetic emission (EME) within a wide frequency range. The TLE9371SJ fulfills stringent EMC test limits without additional external circuitry, such as a common mode choke.

Due to the excellent symmetry combined with the optimized delay symmetry of the receiver the TLE9371SJ supports CAN FD data frames. Depending on the size of the network and its parasitic effects the device supports a transmission rate up to 8 Mbit/s.

Dedicated low-power modes, like standby mode require very low quiescent current while the device is powered up. In standby mode the typical quiescent current on $V_{\rm CC}$ is below 10 μ A while the device can still wake up from a bus signal on the HS CAN bus.

Fail-safe features such as overtemperature protection, output current limitation and the TxD timeout feature protect the TLE9371SJ and the external circuitry from damage.

Туре	Package	Marking
TLE9371SJ	PG-DSO-8	9371

CAN signal improvement transceiver



Table of contents

	Features	1
	Potential applications	1
	Product validation	1
	Description	1
	Table of contents	3
1	Block diagram	5
2	Pin configuration	
2.1 2.2	Pin assignment	6
3 3.1	High-speed CAN functional description High-speed CAN physical layer	
4	Modes of operation	9
4.1	Normal-operating mode	
4.2	Standby mode	
4.3 4.4	Power-down state	
4.4.1	Bus wake-up pattern (WUP)	
4.4.2	RxD pin wake-up behavior	
5	Fail safe functions	. 15
5.1	Short circuit protection	
5.2 5.3	Unconnected logic input pins	
5.4	V _{CC} undervoltage	
5.5	Delay time for mode change	
5.6	Overtemperature protection	. 16
6	General product characteristics	
6.1	Absolute maximum ratings	
6.2 6.3	Functional range	
7	Electrical characteristics	
7.1	Power supply interface	
7.1.1	Current consumption	
7.1.2	Undervoltage detection	
7.2	CAN controller interface	
7.3	Receiver	
7.4 7.5	Transmitter	
7.6	Diagrams	
8	Application information	
8.1	ESD robustness according to IEC 61000-4-2	
8.2	Application example	
8.3	Further application information	. 32

CAN signal improvement transceiver



9	Package information	33
10	Revision history	34



Block diagram

1 Block diagram

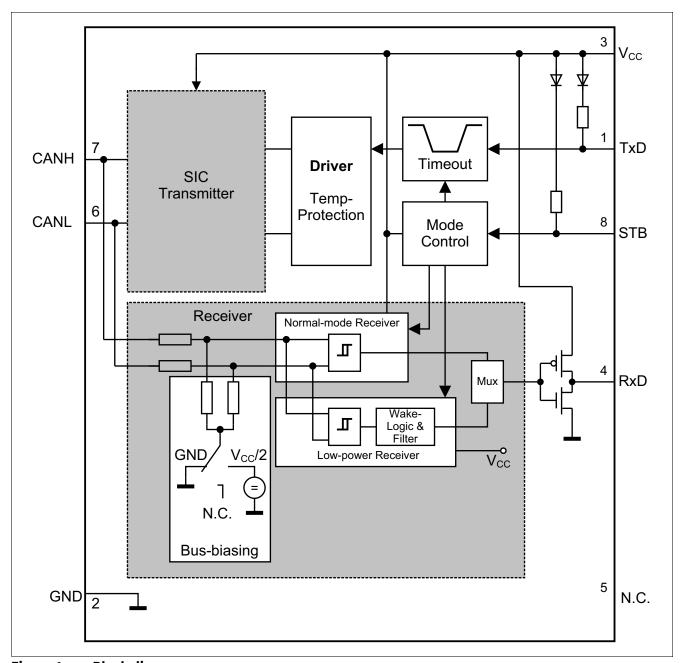


Figure 1 Block diagram



Pin configuration

2 Pin configuration

2.1 Pin assignment

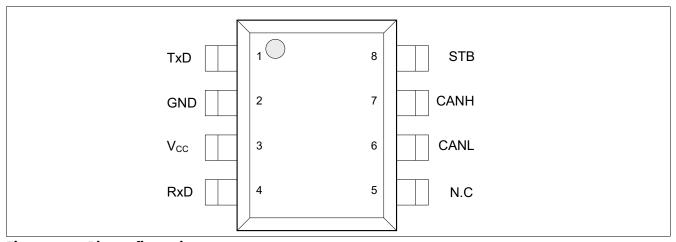


Figure 2 Pin configuration

2.2 Pin definitions and functions

 Table 1
 Pin definitions and functions

Pin No.	Symbol	Function
1	TxD	Transmit data input; Internal pull-up to V_{CC} , "low" for dominant state.
2	GND	Ground
3	V _{cc}	Transmitter supply voltage; 1 uF decoupling capacitor to GND required.
4	RxD	Receive data output; "Low" in dominant state.
5	N.C.	Not connected; Pin has no function and is not connected internally.
6	CANL	CAN bus low level I/O; "Low" in dominant state.
7	CANH	CAN bus high level I/O; "High" in dominant state.
8	STB	Standby input; Internal pull-up to $V_{\rm CC}$, "low" for normal-operating mode.

infineon

High-speed CAN functional description

3 High-speed CAN functional description

HS CAN is a serial bus system that connects microcontrollers, sensors and actuators for real-time control applications. The use of the Controller Area Network (abbreviated CAN) within road vehicles is described by the international standard ISO 11898. According to the 7-layer OSI reference model the physical layer of a HS CAN bus system specifies the data transmission from one CAN node to all other available CAN nodes within the network. The physical layer specification of a CAN bus system includes all electrical specifications of a CAN. The CAN transceiver is part of the physical layer. The TLE9371SJ is a high-speed CAN transceiver with a dedicated bus wake-up function as defined in the latest ISO 11898-2 HS CAN standard.

3.1 High-speed CAN physical layer

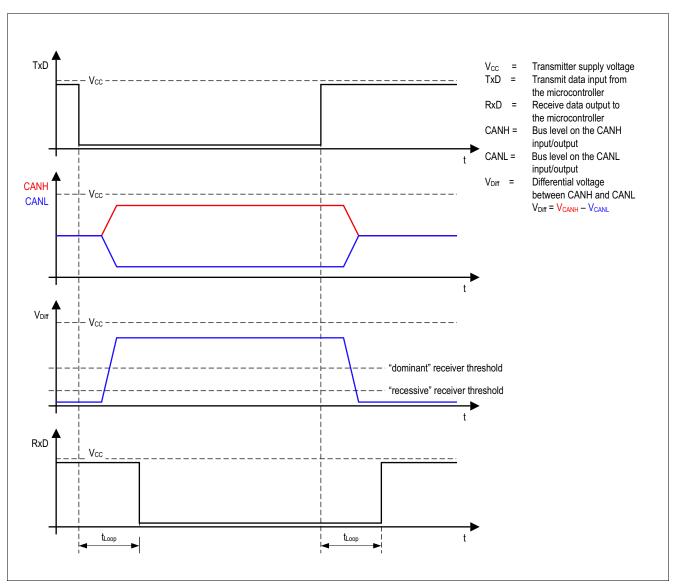


Figure 3 High-speed CAN bus signals and logic signals

CAN signal improvement transceiver



High-speed CAN functional description

The TLE9371SJ is a high-speed CAN transceiver, operating as an interface between the CAN controller and the physical bus medium. A HS CAN is a two wire, differential network, which allows data transmission rates up to 8 Mbit/s. The characteristic for a HS CAN is that the logical high level and logical low level (microcontroller interface) are converted into a differential signal (CAN bus interface) with the states dominant and recessive, see **Figure 3**.

The CANH and CANL pins are the interface to the CAN bus and both pins operate as an input and output. The RxD and TxD pins are the interface to the microcontroller. The pin TxD is the serial data input from the CAN controller, the RxD pin is the serial data output to the CAN controller. The device includes a receiver and a transmitter unit, allowing the transceiver to send data to the bus medium and monitor the data from the bus medium at the same time, see **Figure 1**. The device converts the serial data stream from the transmit data input TxD, into a differential output signal on the CAN bus, provided by the CANH and CANL pins. The receiver stage of the device monitors the data on the CAN bus and converts them to a serial, single-ended signal on the RxD output pin. A "low" signal on the TxD pin creates a dominant signal on the CAN bus. The receiver converts this dominant signal to a "low" signal on the RxD pin, see **Figure 3**. The feature of broadcasting data to the CAN bus and listening to the data traffic on the CAN bus simultaneously is essential to support the bit-to-bit arbitration within the network.

The voltage levels for HS CAN transceivers are defined in ISO 11898-2. Whether a data bit is dominant or recessive depends on the voltage difference between the CANH and CANL pins:

$$V_{\text{Diff}} = V_{\text{CANH}} - V_{\text{CANL}}$$
.

For a dominant signal on the CAN bus the high-speed transceiver creates a differential signal of $V_{\text{Diff}} \ge 1.5 \text{ V}$. To receive a recessive signal from the CAN bus the amplitude of the differential $V_{\text{Diff}} \le 0.5 \text{ V}$.

In a partially supplied high-speed CAN, the CAN bus nodes have different power supply conditions. Some nodes are connected to the common power supply while other nodes are disconnected from the power supply and in power-down state. Regardless of whether the CAN bus node is supplied or not, each node connected to the common bus media must not interfere with the communication. The device supports partially-supplied networks. In power-down state, the receiver input resistors are switched off and the transceiver input has a high resistance.

For permanently supplied ECUs, the HS CAN transceiver, the device provides a stand-by mode. In stand-by mode, the power consumption of the device is optimized to a minimum, while the device is still able to recognize wake-up patterns on the CAN bus and signal the wake-up event to the external microcontroller.

The voltage level on the digital input TxD and on the digital output RxD is determined by the power supply level at the $V_{\rm CC}$ pin. Depending on the voltage level at the $V_{\rm CC}$ pin, the signal levels on the logic pins (STB, TxD and RxD) are compatible with microcontrollers having a 5 V I/O supply.



Modes of operation

4 Modes of operation

The device supports the following modes of operation, see Figure 4:

- · Normal-operating mode
- Standby mode

The mode selection input pin STB triggers mode changes. If a wake-up event occurs on the HS CAN bus, then the device indicates that on the RxD output pin in stand-by mode, but it does not trigger a mode change. An power-down event on the supply VCC powers down the device.

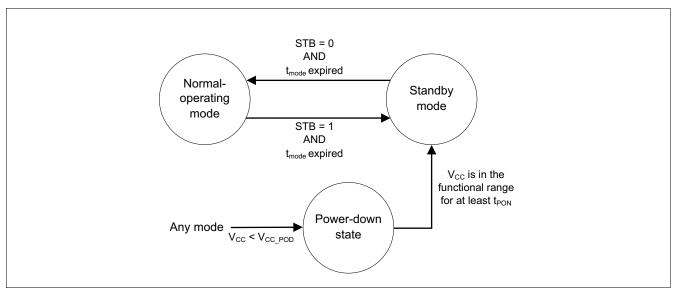


Figure 4 Mode state diagram



Modes of operation

4.1 Normal-operating mode

In normal-operating mode all functions of the device are available and the device is fully functional. Data can be received from the HS CAN bus as well as be transmitted to the HS CAN bus.

- The transmitter is enabled and drives data stream on the TxD input pin to the bus pins CANH and CANL
- The receiver is enabled and converts the signals from the bus to a serial data stream on the RxD output pin
- The bus biasing is connected to $V_{\rm CC}/2$ if $V_{\rm CC} > V_{\rm CC_UV}$
- The TxD timeout function is enabled, see Chapter 5.4
- The overtemperature protection is enabled, see Chapter 5.6
- The undervoltage detection on V_{CC} is enabled, see Chapter 5.3

Conditions for entering normal-operating mode of the device:

• If $V_{CC} > V_{CC_POD}$ and the STB pin is "low", then the device enters normal-operating mode after t_{Mode} from standby mode, see **Figure 4**

If a "low" signal is applied on TxD input pin during a mode change to normal-operating mode, device disables the transmitter as long as "low" signal is applied on the TxD input pin. If a "high" signal is applied on the TxD input pin for at least t_{TxD} rel, then the device enables the transmitter, see **Figure 5**.

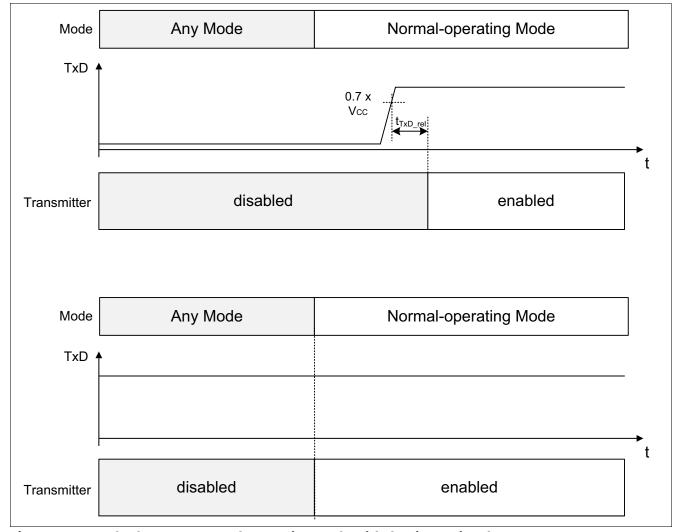


Figure 5 Mode change to normal-operating mode with dominant signal on TxD

CAN signal improvement transceiver



Modes of operation

4.2 Standby mode

The standby mode is the low-power mode of the device. In standby mode the following functions are defined:

- The transmitter is disabled and does not drive the data stream on the TxD input pin to the bus pins CANH and CANL
- The normal-mode receiver is disabled and the data available on the bus is blocked.
- The device monitors the CAN bus for a valid wake-up pattern, see Chapter 4.4.
- The RxD output pin indicates a CAN bus wake-up, see Chapter 4.4.2
- Bus biasing is connected to GND
- TxD dominant timeout function is disabled
- · The overtemperature protection is disabled
- The undervoltage detection on V_{CC} is disabled, see Chapter 5.3

Conditions for entering standby mode of the device:

- If $V_{CC} > V_{CC_POD}$ and the STB pin is "high", then the device enters standby mode after t_{Mode} from normal-operation mode
- If V_{CC} is in the functional rage for at least t_{PON} , then the device enters standby mode from power-down state



Modes of operation

4.3 Power-down state

In power-down state the device is not functional and has the following behavior:

- · The transmitter and receiver are disabled
- The bus biasing is set to high impedance
- The TxD timeout function is disabled
- The overtemperature protection is disabled
- The undervoltage detection on V_{CC} is disabled
- RxD follows the V_{CC} voltage

Conditions for entering power-down state of the device:

• V_{CC} is below the V_{CC_POD} threshold

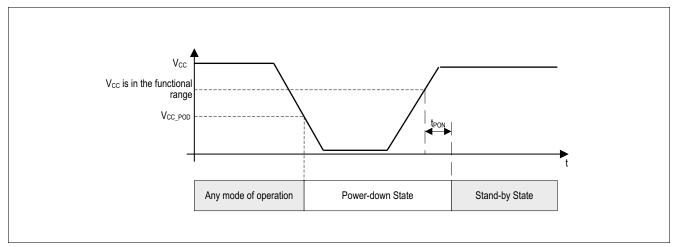


Figure 6 Power-down and power-up behavior



Modes of operation

4.4 Bus wake-up pattern (WUP) detection

The device has implemented the bus wake-up mechanism according to ISO 11898-2:2016. In standby mode the low power receiver monitors the activity on the CAN bus and in case it detects a wake-up pattern, it indicates the wake-up signal on the RxD output pin. A wake-up event does not trigger a mode change. The device remains in standby mode until the microcontroller has requested a mode change to the normal-operating mode.

4.4.1 Bus wake-up pattern (WUP)

The wake-up pattern contains a dominant signal with the pulse width $t_{\rm Filter}$, followed by a recessive signal with the pulse width $t_{\rm Filter}$ and another dominant signal with the pulse width $t_{\rm Filter}$. $t_{\rm Wake}$ starts at the first valid dominant pulse (pulse width $> t_{\rm Filter}$). The subsequent recessive and dominant pulse must occur within $t_{\rm Wake}$ to fulfill a wake-up pattern, see **Figure 7**. As long as the device does not detect a wake-up event, the RxD output remains "high".

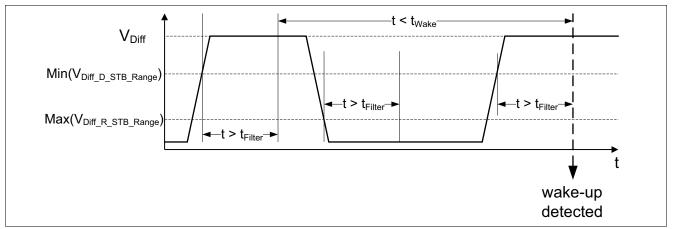


Figure 7 Remote wake-up signal

4.4.2 RxD pin wake-up behavior

If the device detects a wake-up event, then it sets the RxD output pin to "low" and then the RxD output follows the CAN bus signal with the delay of t_{WL} as long as the pulse width exceeds the filter time t_{Filter} , see **Figure 8**.



Modes of operation

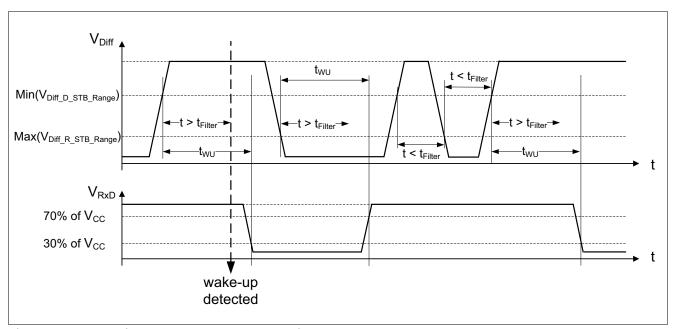


Figure 8 RxD signal follows the CAN bus signal

If at least one of the following conditions is fulfilled, then the device disables the RxD pin wake up behavior:

- A mode change to normal-operating mode is performed during a wake-up pattern
- The voltage supply $V_{CC} < V_{CC_POD}$



Fail safe functions

5 Fail safe functions

5.1 Short circuit protection

The CANH and CANL bus pins are proven to cope with a short circuit fault against GND and against the supply voltages. A current limiting circuit protects the transceiver against damages. If the device heats up due to a continuous short on the CANH or CANL pin, the internal overtemperature protection switches off the bus transmitter.

5.2 Unconnected logic input pins

If the input pins are not connected and floating, then the integrated pull-up resistors at the digital input pins force the device into fail safe behavior, see .

Table 2 Unconnected logical input pins

Input signal	Default state	Comment
TxD	"High"	Pull-up resistor to V _{CC}
STB	"High"	Pull-up resistor to V _{CC}

5.3 *V*_{cc} undervoltage

If $V_{CC} < V_{CC_{UV}}$, then the V_{CC} supply of the transceiver is in undervoltage condition with the following functions independent of the transceiver mode, see **Figure 9**:

- Transmitter is deactivated
- The bus biasing is set to GND

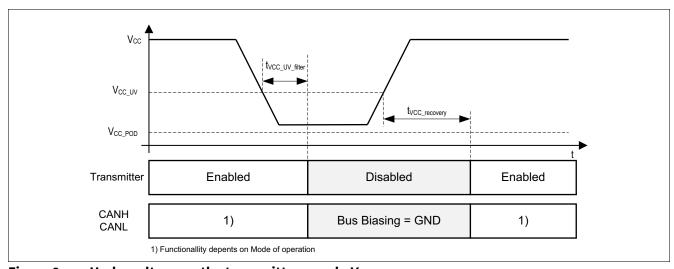


Figure 9 Undervoltage on the transmitter supply V_{CC}

5.4 TxD timeout function

If the logical signal on the TxD pin is permanently "low", then the TxD timeout feature protects the CAN bus from blocked communication due to this errant logic signal. A permanent "low" signal on the TxD pin can occur due to a locked-up microcontroller or in a short circuit on the printed circuit board, for example. In normal-operating mode, a "low" signal on the TxD pin for the time $t > t_{TXD_TO}$ enables the TxD timeout feature

CAN signal improvement transceiver



Fail safe functions

and the device disables the transmitter, see **Figure 10**. The receiver is still active and the RxD output pin continues monitoring data on the bus.

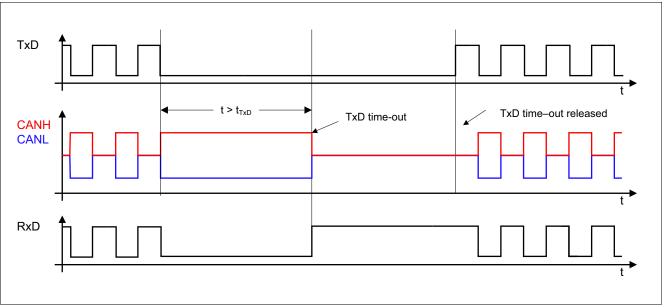


Figure 10 TxD timeout function

5.5 Delay time for mode change

The HS CAN transceiver device changes the mode of operation within the time window $t_{\rm Mode}$. During the mode change from standby mode to a non-low power mode the device sets the RxD output to "high" and RxD does not reflect the status on the CANH and CANL input pins.

5.6 Overtemperature protection

The device has an integrated overtemperature detection to protect the device against thermal overstress of the transmitter. The overtemperature protection is only active in normal-operating mode. If an overtemperature condition ($T_{\text{Junction}} \ge T_{\text{JSD}}$) occurs, then the temperature sensor disables the transmitter while the transceiver remains in normal-operating mode. After the device cools down ($T_{\text{Junction}} < T_{\text{JSD}}$) the device activates the transmitter again, see **Figure 11**. A hysteresis is implemented within the temperature sensor.

(infineon

Fail safe functions

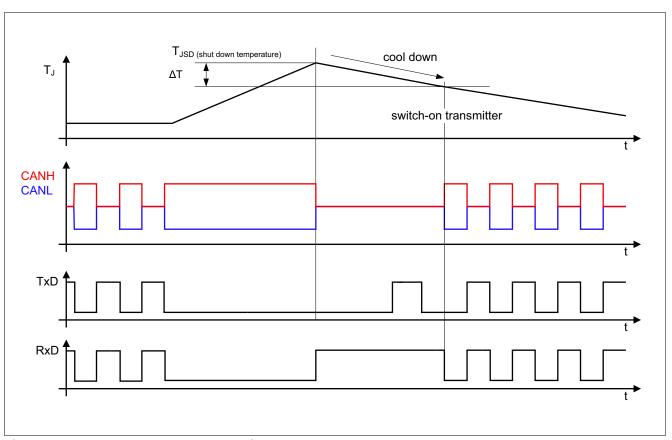


Figure 11 Overtemperature protection



General product characteristics

6 General product characteristics

6.1 Absolute maximum ratings

Table 3 Absolute maximum ratings voltages, currents and temperatures¹⁾

All voltages with respect to ground; positive current flowing into pin; (unless otherwise specified)

Parameter	Symbol		Value	!S	Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
Voltages			-	_ '			<u> </u>
Transmitter supply voltage	$V_{\rm cc}$	-0.3	-	6.0	V	_	P_7.1.1
CANH and CANL DC voltage versus GND	V _{CANH}	-40	-	40	V	-	P_7.1.3
Differential voltage between CANH and CANL	V _{CAN_Diff}	-40	-	40	V	-	P_7.1.4
Voltages at the digital I/O pins: STB, TxD	V _{MAX_IO}	-0.3	-	6.0	V	-	P_7.1.8
Voltages at the digital I/O pins: RxD	$V_{\text{MAX_RxD}}$	-0.3	-	V _{CC} +0.3	V	-	P_7.1.10
Currents	1		· ·	1	"	1	
RxD output current	I _{RxD}	-5	_	5	mA	_	P_7.1.11
Temperatures	ı						
Junction temperature	$T_{\rm j}$	-40	-	150	°C	_	P_7.1.12
Storage temperature	T _S	-55	_	150	°C	_	P_7.1.13
ESD robustness			*		*		·
ESD robustness at CANH, CANL versus GND	V _{ESD_HBM_CAN}	-8	_	8	kV	²⁾ HBM; 100 pF via 1.5 kΩ	P_7.1.14
ESD robustness at all other pins	V _{ESD_HBM_ALL}	-2	_	2	kV	²⁾ HBM; 100 pF via 1.5 kΩ	P_7.1.15
ESD robustness at corner pins	V _{ESD_CDM_CP}	-750	-	750	V	3) CDM	P_7.1.16
ESD robustness at any other pins	V _{ESD_CDM}	-500	-	500	V	3) CDM	P_7.1.17

- 1) Not subject to production test, specified by design.
- 2) Human body model (HBM) robustness according to AE Q100-002
- 3) Charge device model (CDM) robustness according to AEC Q100-011 Rev-D; voltage level refers to test condition (TC) mentioned in the standard.

Note: Latchup robustness: class II according to AEC - Q100-04.

CAN signal improvement transceiver



General product characteristics

Note:

Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal-operating range. Protection functions are not designed for continuos repetitive operation.

CAN signal improvement transceiver



General product characteristics

6.2 Functional range

Table 4 Functional range

Parameter	Symbol		Value	S	Unit	Note or Test Condition	Number
		Min.	Тур.	Max.			
Supply voltages		*	·		.		-
Transmitter supply voltage	$V_{\rm cc}$	4.75	-	5.25	V	_	P_7.2.1
Thermal parameters	-	1					1
Junction temperature	T _i	-40	_	150	°C	1)	P_7.2.3

¹⁾ Not subject to production test, specified by design.

Note:

Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the related electrical characteristics table.

6.3 Thermal resistance

Note:

This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, please visit **www.jedec.org**.

Table 5 Thermal resistance¹⁾

Parameter	Symbol		Values			Note or	Number
		Min.	Тур.	Max.		Test Condition	
Thermal resistances		•	•		•		
Junction to ambient PG-DSO-8	R _{thJA_DSO8}	-	120	-	K/W	2)	P_7.3.2
Thermal shutdown (junction tem	perature)	- 11		II.	- 11:		
Thermal shutdown temperature, rising	T_{JSD}	170	180	190	°C	Temperature falling: minimum 150°C	P_7.3.3
Thermal shutdown hysteresis	ΔΤ	5	10	20	K	_	P_7.3.4

¹⁾ Not subject to production test, specified by design.

²⁾ Specified R_{thJA} value is according to Jedec JESD51-2,-7 at natural convection on FR4 2s2p board. The product (chip and package) was simulated on a 76.2 mm \times 114.3 mm \times 1.5 mm board with two inner copper layers (2 \times 70 μ m Cu, 2 \times 35 μ m Cu).

CAN signal improvement transceiver



Electrical characteristics

7 Electrical characteristics

7.1 Power supply interface

7.1.1 Current consumption

Table 6 Current consumption

Parameter	Symbol	ol Values				Note or	Number
		Min.	Тур.	Max.		Test Condition	
Current consumption at V _{CC} normal-operating mode, recessive state	I _{CC_R}	_	2.8	4	mA	$V_{TxD} = V_{CC};$ $V_{STB} = 0 V;$ $V_{CANH} = V_{CANL} = V_{CC}/2$	P_8.1.4
Current consumption at V_{CC} normal-operating mode, dominant state	I _{CC_D}	_	38	48	mA	$V_{\text{TxD}} = V_{\text{STB}} = 0 \text{ V};$ $t < t_{\text{TxD}}$	P_8.1.9
Current consumption at V_{CC} standby mode	I _{CC(STB)}	_	_	20	μΑ	$V_{TxD} = V_{STB} = V_{CC}$	P_8.1.15

CAN signal improvement transceiver



Electrical characteristics

7.1.2 Undervoltage detection

Table 7 Undervoltage detection

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
V _{CC} undervoltage threshold	V _{CC_UV}	4.25	4.35	4.5	V	_	P_8.1.25
V _{CC} undervoltage filter time	t _{VCC_UV_filter}	1	_	10	μs	1)	P_8.1.27
$V_{\rm CC}$ undervoltage recovery time	t _{VCC_recovery}	-	_	70	μs	1)	P_8.1.28
$V_{\rm CC}$ power-down threshold	V _{CC_POD}	2.0	2.5	3.0	V	_	P_8.1.31
Power-up delay time	t_{PON}	_	-	280	μs	1)	P_8.1.33
						Figure 6	

¹⁾ Not subject to production test, specified by design.

CAN signal improvement transceiver



Electrical characteristics

7.2 CAN controller interface

Table 8 CAN controller interface

Parameter	Symbol	Values		Unit	Note or	Number	
		Min.	Тур.	Мах.		Test Condition	
Receiver output RxD					•		
"High" level output current	I_{RxD_H}	-	-2	-1	mA	$V_{\text{RxD}} = V_{\text{CC}} - 0.4 \text{ V};$ $V_{\text{Diff}} < 0.5 \text{ V}$	P_8.2.2
"Low" level output current	I_{RxD_L}	1	2	-	mA	$V_{\text{RxD}} = 0.4 \text{ V};$ $V_{\text{Diff}} > 0.9 \text{ V}$	P_8.2.3
Transmitter input TxD							
"High" level input voltage	$V_{TxD_{H}}$	0.7 × V _{cc}	-	6.0	V	Recessive state	P_8.2.5
"Low" level input voltage	V_{TxD_L}	-0.3	-	0.3 × V _{cc}	V	Dominant state	P_8.2.7
Internal pull-up resistor TxD	R_{TxD}	35	50	70	kΩ	_	P_8.2.9
Input capacitance	C_{TxD}	-	_	10	pF	1)	P_8.2.10
TxD dominant timeout	t_{TxD}	1	-	4	ms	Normal-operating mode	P_8.2.11
Standby input STB	·						·
"High" level input voltage	$V_{Mode_{H}}$	0.7 × V _{cc}	-	6.0	V	-	P_8.2.15
"Low" level input voltage	$V_{ m Mode_L}$	-0.3	-	0.3 × V _{cc}	V	Normal-operating mode	P_8.2.17
Internal pull-up resistor	R _{Mode}	35	50	70	kΩ	_	P_8.2.19
Input capacitance	C_{Mode}	-	_	10	pF	1)	P_8.2.20

¹⁾ Not subject to production test, specified by design.

CAN signal improvement transceiver



Electrical characteristics

7.3 Receiver

Table 9 Receiver characteristics

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
Common mode range	$V_{\rm CMR}$	-12	_	12	V	_	P_8.3.1
Differential range dominant state, normal-operating mode	$V_{Diff_D_Range}$	0.9	_	8.0	V	1) V _{CMR}	P_8.3.4
Differential range recessive state, normal-operating mode	$V_{\mathrm{Diff_R_Range}}$	-3.0	_	0.5	V	1) V _{CMR}	P_8.3.6
Differential range dominant state, standby mode	$V_{Diff_{-}D_{-}STB_{-}R}$ ange	1.15	_	8.0	V	1) V _{CMR}	P_8.3.8
Differential range recessive state, standby mode	V _{Diff_R_STB_R} ange	-3.0	_	0.4	V	1) V _{CMR}	P_8.3.10
Single ended internal resistance	R _{CAN_H} , R _{CAN_L}	30	_	50	kΩ	1) recessive state; $-2 \text{ V} \le V_{\text{CANH}} \le 7 \text{ V};$ $-2 \text{ V} \le V_{\text{CANL}} \le 7 \text{ V}$	P_8.3.12
Differential internal resistance	R _{Diff}	60	_	100	kΩ	1) recessive state; $-2 \text{ V} \le V_{\text{CANH}} \le 7 \text{ V};$ $-2 \text{ V} \le V_{\text{CANL}} \le 7 \text{ V}$	P_8.3.13
Input resistance deviation between CANH and CANL	$\Delta R_{\rm i}$	-1	_	1	%	¹⁾ recessive state; $V_{\text{CANH}} = V_{\text{CANL}} = 5 \text{ V}$	P_8.3.14
Input capacitance CANH, CANL versus GND	C _{In}	-	20	40	pF	1)2)	P_8.3.15
Differential input capacitance	C_{InDiff}	-	10	20	pF	1)2)	P_8.3.16

¹⁾ Not subject to production test, specified by design.

²⁾ S2P-method; f = 10 MHz.

CAN signal improvement transceiver



Electrical characteristics

7.4 Transmitter

Table 10 Transmitter characteristics

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
CANL, CANH recessive state output voltage	$V_{CANL,H}$	2.0	2.5	3.0	V	Normal-operating mode; $V_{TxD} = V_{CC};$ no load	P_8.4.2
CANH, CANL recessive state differential output voltage $V_{\text{Diff}_{-R_{-}NM}} = V_{\text{CANH}} - V_{\text{CANL}}$	V _{Diff_R_NM}	-50	_	50	mV	Normal-operating mode; $V_{TxD} = V_{CC};$ no load	P_8.4.4
CANL dominant state output voltage, normal-operating mode	V_{CANL}	0.5	_	2.25	V	$V_{\text{TXD}} = 0 \text{ V};$ 45 $\Omega < R_{\text{L}} < 65 \Omega$	P_8.4.5
CANH dominant state output voltage, normal-operating mode	V _{CANH}	2.75	_	4.5	V	$V_{\text{TXD}} = 0 \text{ V};$ 45 $\Omega < R_{\text{L}} < 65 \Omega$	P_8.4.6
Differential voltage dominant state, normal-operating mode	$V_{\mathrm{Diff_D_NM}}$	1.5	2.0	3.0	V	$V_{\text{Diff}} = V_{\text{CANH}} - V_{\text{CANL}};$ $V_{\text{TXD}} = 0 \text{ V};$ $50 \Omega < R_{\text{L}} < 65 \Omega$	P_8.4.7
Differential voltage extended bus load	V _{Diff_EXT_BL}	1.4	2.0	3.3	V	Dominant state; normal-operating mode; $V_{TxD} = 0 \text{ V};$ $45 \Omega < R_L < 70 \Omega$	P_8.4.8
Differential voltage dominant state high extended bus load normal-operating mode	V _{Diff_HEXT_BL}	1.5	_	5.0	V	$V_{\text{TxD}} = 0 \text{ V};$ $R_{\text{L}} = 2240 \Omega$	P_8.4.9
CANH, CANL recessive output voltage difference standby mode	V_{Diff_STB}	-0.2	_	0.2	V	No load	P_8.4.10
CANL, CANH recessive output voltage standby mode	V _{CANL,H_STB}	-0.1	-	0.1	V	No load	P_8.4.11
Driver symmetry $V_{\text{SYM}} = V_{\text{CANH}} + V_{\text{CANL}}$	V_{SYM}	0.95 × V _{cc}	1.0 × V _{CC}	1.05 × V _{CC}	V	$C_1 = 4.7 \text{ nF}$	P_8.4.12
CANL short circuit current	I _{CANLsc}	-115	-	115	mA	$-3 V < V_{CANLshort} < 18 V;$ $t < t_{TXD};$ $V_{TXD} = 0 V$	P_8.4.13
CANH short circuit current	I _{CANHsc}	-115	_	115	mA	$-3 \text{ V} < V_{\text{CANHshort}} < 18 \text{ V};$ $t < t_{\text{TxD}};$ $V_{\text{TxD}} = 0 \text{ V}$	P_8.4.14

CAN signal improvement transceiver



Electrical characteristics

Table 10 Transmitter characteristics (cont'd)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
CANH leakage current	I _{CANH,lk}	-5	-	5	μΑ	$V_{\text{CC}} = 0 \text{ V};$ $0 \text{ V} < V_{\text{CANH}} \le 5 \text{ V};$ $V_{\text{CANH}} = V_{\text{CANL}}$	P_8.4.16
CANL leakage current	I _{CANL,lk}	-5	-	5	μΑ	$V_{\text{CC}} = 0 \text{ V};$ $0 \text{ V} < V_{\text{CANL}} \le 5 \text{ V};$ $V_{\text{CANH}} = V_{\text{CANL}}$	P_8.4.18
Signal improvement resistance	R _{SI}	75	-	125	Ω		P_8.4.19
Signal improvement time	$t_{\sf SIC}$	450	-	530	ns		P_8.4.20

¹⁾ Not subject to production test, specified by design.

²⁾ V_{SYM} observed during dominant and recessive state and also during the transition from dominant to recessive and vice versa, while TxD is stimulated by a square wave signal. This parameter must be valid for all the possible transmission rates.



Electrical characteristics

7.5 Dynamic transceiver parameters

Table 11 Electrical characteristics dynamic transceiver parameters

Parameter	Symbol		Values			Note or	Number
		Min.	Тур.	Max.		Test Condition	
Loop delay from TxD to RxD	t _{Loop}	80	-	190	ns	$C_1 = 0 \text{ pF};$ $C_2 = 100 \text{ pF};$ $C_{RxD} = 25 \text{ pF};$ $C_{VCC} = 100 \text{ nF};$ $R_L = 60 \Omega;$ $V_{TxD} = \text{rise } (10\% \text{ to } 90\%)$ and fall $(90\% \text{ to } 10\%)$ time < 10 ns; $125 \text{ kbit/s} < 1/t_{Bit} < 8 \text{ Mbit/s};$ see Figure 12, Figure 13	P_8.5.1
Transmitter propagation delay TxD to bus ("high" until recessive; "low" until dominant)	t _{prop_} T	30	-	80	ns	$C_1 = 0 \text{ pF};$ $C_2 = 100 \text{ pF};$ $C_{VCC} = 100 \text{ nF};$ $R_L = 60 \Omega;$ $V_{TXD} = \text{rise } (10\% \text{ to } 90\%)$ and fall $(90\% \text{ to } 10\%)$ time < 10 ns; see Figure 12, Figure 13	P_8.5.3
Propagation delay bus to RxD (dominant until "low"; recessive until "high")	t _{prop_R}	30	-	110	ns	$C_1 = 0 \text{ pF};$ $C_2 = 100 \text{ pF};$ $C_{RXD} = 25 \text{ pF};$ $C_{VCC} = 100 \text{ nF};$ $R_L = 60 \Omega;$ $V_{TXD} = \text{rise } (10\% -> 90\%)$ and fall $(90\% -> 10\%)$ time < 10 ns; see Figure 12, Figure 13	P_8.5.4
Delay times		1	1	1	1	1	1
Delay time for mode change	t _{Mode}	-	_	20	μs	_	P_8.5.5
Transmitter release time after entering normal-operating mode in dominant state	t_{TxD_rel}	_	_	5	μs	-	P_8.5.6
CAN activity filter time	t _{Filter}	0.5	-	1.8	μs	_	P_8.5.7
Bus wake-up timeout	$t_{\sf Wake}$	0.8	_	10	ms	1)	P_8.5.8
Bus wake-up delay time	t_{WU}	_	_	5	μs	_	P_8.5.9

CAN signal improvement transceiver



Electrical characteristics

Table 11 Electrical characteristics dynamic transceiver parameters (cont'd)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
CAN FD characteristics	•	'		-	*		•
Loop delay symmetry	$\Delta t_{\mathrm{Bit}(RxD)}$	-30	-	20	ns	$\Delta t_{\rm Bit(RxD)} = t_{\rm Bit(RxD)}$ - $t_{\rm Bit(TxD)}$; $C_1 = 0$ pF; $C_2 = 100$ pF; $C_{\rm RxD} = 25$ pF; $C_{\rm VCC} = 100$ nF; $R_{\rm L} = 60$ Ω ; $V_{\rm TxD} = {\rm rise}~(10\%~{\rm to}~90\%)$ and fall (90% to 10%) time < 10 ns; 125 kbit/s < $1/t_{\rm Bit}$ < 8 Mbit/s; see Figure 12, Figure 13	P_8.5.10
Receiver propagation delay symmetry (received recessive bit width)	Δt_{Rec}	-20	-	15	ns	$\Delta t_{\rm Rec} = t_{\rm Bit(RxD)} - t_{\rm Bit(Bus)};$ $C_1 = 0 \rm pF;$ $C_2 = 100 \rm pF;$ $C_{\rm RxD} = 25 \rm pF;$ $C_{\rm VCC} = 100 \rm nF;$ $R_{\rm L} = 60 \Omega;$ $V_{\rm TxD} = \rm rise (10\% to 90\%)$ and fall $(90\% to 10\%)$ time < 10 ns; 125 kbit/s < 1/ $t_{\rm Bit}$ < 8 Mbit/s; see Figure 12, and Figure 14	P_8.5.11
Transmitter propagation delay symmetry (transmitted recessive bit width)	$\Delta t_{ m Bit(Bus)}$	-10	_	10	ns	$\Delta t_{\rm Bit(Bus)} = t_{\rm Bit(Bus)} - t_{\rm Bit(TxD)};$ $C_1 = 0 \rm pF;$ $C_2 = 100 \rm pF;$ $C_{\rm RxD} = 25 \rm pF;$ $C_{\rm VCC} = 100 \rm nF;$ $R_{\rm L} = 60 \Omega;$ $V_{\rm TxD} = \rm rise (10\% to 90\%)$ and fall $(90\% to 10\%)$ time < 10 ns; 125 kbit/s < $1/t_{\rm Bit} < 8 \rm Mbit/s;$ see Figure 12 and Figure 14	P_8.5.12

¹⁾ Not subject to production test, specified by design.



Electrical characteristics

7.6 Diagrams

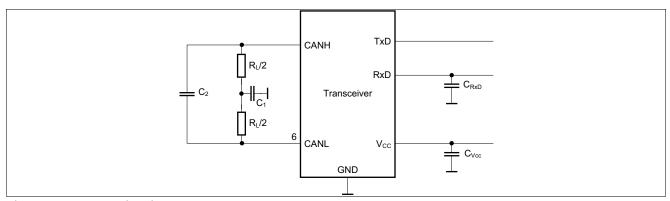


Figure 12 Test circuit

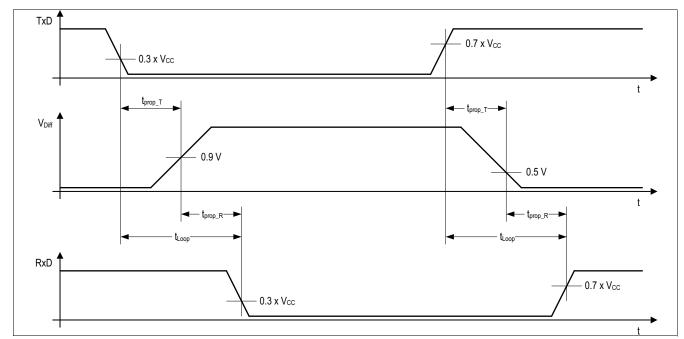


Figure 13 Timing diagram for dynamic characteristics



Electrical characteristics

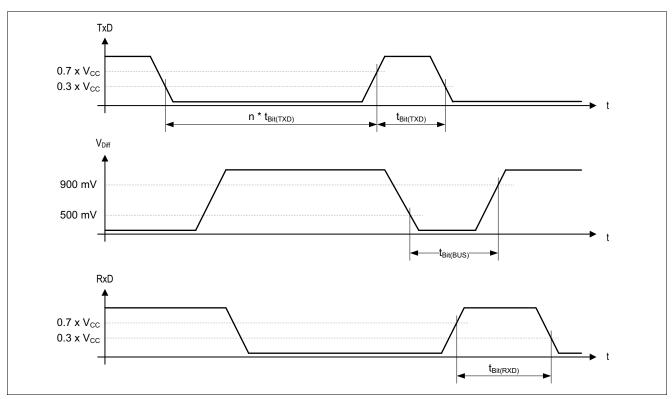


Figure 14 CAN FD electrical parameters



Application information

8 Application information

8.1 ESD robustness according to IEC 61000-4-2

Tests for ESD robustness according to IEC 61000-4-2 Gun test (150 pF, 330 Ω) have been performed. The results and test conditions are available in a separate test report.

Table 12 ESD robustness according to IEC 61000-4-2

Performed Test	Result	Unit	Remarks
Electrostatic discharge voltage at pin CANH and CANL versus GND	≥ +8	kV	1) Positive pulse
Electrostatic discharge voltage at pin CANH and CANL versus GND	≤-8	kV	1) Negative pulse

¹⁾ Not subject to production test. ESD robustness ESD GUN according to GIFT / ICT paper: "EMC Evaluation of CAN Transceivers, version IEC TS62228", section 4.3. (DIN EN 61000-4-2).

Tested by external test facility IBEE Zwickau – EMC test report available on request.

8.2 Application example

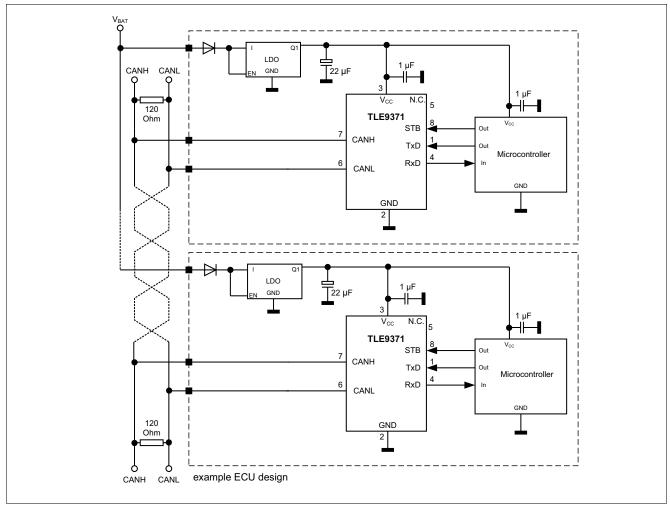


Figure 15 Application diagram

CAN signal improvement transceiver



Application information

8.3 Further application information

• For further information you may visit: http://www.infineon.com/tle9371vsj



Package information

9 Package information

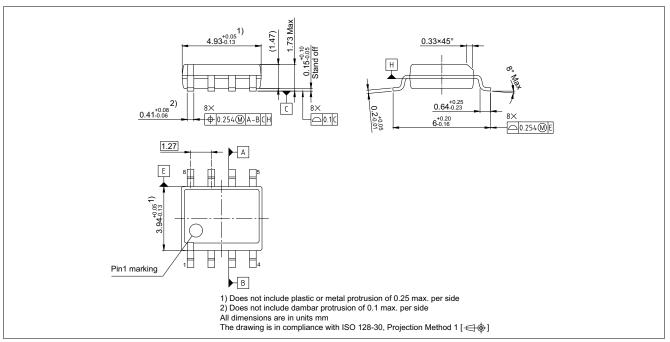


Figure 16 PG-DSO-8

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Further information on packages

https://www.infineon.com/packages

CAN signal improvement transceiver



Revision history

10 Revision history

Revision	Date	Changes
1.0	2023-02-28	Datasheet created

Trademarks

Edition 2022-11-18 Published by Infineon Technologies AG 81726 Munich, Germany

© 2023 Infineon Technologies AG. All Rights Reserved.

Do you have a question about any aspect of this document?

Email: erratum@infineon.com

Document reference Z8F65761338

IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for CAN Interface IC category:

Click to view products by Infineon manufacturer:

Other Similar products are found below:

PCA82C250T/N4 UJA1169TK/3Z TLE7251VLE UM3608QA TJA1055T/3/1 TLE9251VLE TLE9250VLE ATA6562-GAQW1
UJA1169TK/3 UJA1169TK/F UJA1169TK/X/FZ TLE9471ES V33 CA-IF1043NF-Q1 CA-IF1043DF-Q1 HX82C251-P MCP2561-HMF
MCP2510-E/P MCP2515-E/P TJA1042T,118 TJA1050T/CM TJA1042T3CM,118 TJA1051T3CM,118 TJA1042T1J TJA1042T31J
TJA1051TCM,118 TJA1051T/E,118 TJA1052IT/5Y UJA1078ATW/5V0/WDJ MCP2515-I/ML NCV7342D13R2G MAX13051ESA+T
SJA1000T/N1.118 MCP2562FD-EP MCP2561FD-EP TLE6251DSXUMA2 MCP2562T-H/MF TLE7250GVIOXUMA2 NCV7351FD13R2G
MCP2562FDT-E/MF TLE62513GXUMA2 TLE9250SJXUMA1 TJF1052IT/2Y TLE9251VLEXUMA1 MCP2544FDT-E/MNY
MCP2562FDT-E/SN UJA1076ATW/5V0WD,1 TLE7250GXUMA2 MCP2544FDT-H/MNY MCP2542WFDT-E/MNY MCP2542FDT-E/MNY